117TH CONGRESS 2D SESSION

H. R. 7104

To amend the Internal Revenue Code of 1986 to establish the semiconductor manufacturing investment credit.

IN THE HOUSE OF REPRESENTATIVES

March 16, 2022

Mr. McCaul (for himself, Ms. Matsui, Mr. Kelly of Pennsylvania, Ms. Delbene, Ms. Stefanik, Mr. Kildee, Mr. Katko, Ms. Slotkin, and Mr. Meijer) introduced the following bill; which was referred to the Committee on Ways and Means

A BILL

To amend the Internal Revenue Code of 1986 to establish the semiconductor manufacturing investment credit.

- 1 Be it enacted by the Senate and House of Representa-
- 2 tives of the United States of America in Congress assembled,
- 3 SECTION 1. SHORT TITLE.
- 4 This Act may be cited as the "Facilitating American-
- 5 Built Semiconductors Act" or the "FABS Act".
- 6 SEC. 2. SEMICONDUCTOR MANUFACTURING INVESTMENT
- 7 CREDIT.
- 8 (a) IN GENERAL.—Subpart E of part IV of sub-
- 9 chapter A of chapter 1 of the Internal Revenue Code of

1	1986 is amended by inserting after section 48C the fol-
2	lowing new section:
3	"SEC. 48D. SEMICONDUCTOR MANUFACTURING INVEST-
4	MENT CREDIT.
5	"(a) In General.—For purposes of section 46, the
6	semiconductor manufacturing investment credit for any
7	taxable year is an amount equal to the sum of—
8	"(1) 25 percent of the qualified investment for
9	such taxable year with respect to any semiconductor
10	manufacturing facility property, and
11	"(2) 25 percent of the qualified semiconductor
12	design expenditures paid or incurred during the tax-
13	able year.
14	"(b) Qualified Investment With Respect to
15	SEMICONDUCTOR MANUFACTURING FACILITY PROP-
16	ERTY.—
17	"(1) In general.—For purposes of subsection
18	(a)(1), the qualified investment with respect to any
19	semiconductor manufacturing facility property for
20	any taxable year is the basis of any qualified prop-
21	erty placed in service by the taxpayer during such
22	taxable year which is part of any semiconductor
23	manufacturing facility property.

1	"(2) Qualified property.—For purposes of
2	this subsection, the term 'qualified property' means
3	property—
4	"(A) which is tangible property (including
5	a building or its structural components) which
6	is an integral part of any semiconductor manu-
7	facturing facility property,
8	"(B) with respect to which depreciation (or
9	amortization in lieu of depreciation) is allow-
10	able,
11	"(C) which is—
12	"(i) constructed, reconstructed, or
13	erected by the taxpayer, or
14	"(ii) acquired by the taxpayer if the
15	original use of such property commences
16	with the taxpayer, and
17	"(D) the primary purpose of which is to
18	manufacture or process, or perform research
19	with respect to, semiconductors or semicon-
20	ductor tooling equipment.
21	"(3) Semiconductor manufacturing facil-
22	ITY PROPERTY.—For purposes of this subpart, the
23	term 'semiconductor manufacturing facility property'
24	means a facility for which the primary purpose is
25	the fabrication, assembly, testing and packaging of

- semiconductor chips; semiconductor manufacturing equipment used in these and related processes such as material-handling and photomasking; or associated metrology, material-handling and other related tools.
- 6 "(4) COORDINATION WITH REHABILITATION
 7 CREDIT.—The qualified investment with respect to
 8 any semiconductor manufacturing facility property
 9 for any taxable year shall not include that portion
 10 of the basis of any property which is attributable to
 11 qualified rehabilitation expenditures (as defined in
 12 section 47(c)(2)).
- "(c) QUALIFIED SEMICONDUCTOR DESIGN EXPENDI TURES.—For purposes of this section—
 - "(1) IN GENERAL.—Except as otherwise provided in this subsection, the term 'qualified semiconductor design expenditures' means the amounts which are paid or incurred by the taxpayer during the taxable year which would be described in subsection (b) of section 41 if such subsection were applied with the modifications set forth in paragraph (3).
- 23 "(2) EXCLUSION FOR AMOUNTS FUNDED BY
 24 GRANTS, ETC.—The term 'qualified semiconductor
 25 design expenditures' shall not include any amount to

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1	the extent such amount is funded by any grant, con-
2	tract, or otherwise by another person (or any gov-
3	ernmental entity).
4	"(3) Modifications.—For purposes of para-
5	graph (1), subsection (b) of section 41 shall be ap-
6	plied—
7	"(A) by substituting 'semiconductor re-
8	search' for 'qualified research' each place it ap-
9	pears in paragraphs (2) and (3) of each sub-
10	section,
11	"(B) by substituting '100 percent' for '65
12	percent' in paragraph (3)(A) of such sub-
13	section, and
14	"(C) by substituting '100 percent' for '75
15	percent' in paragraph (3)(C)(i) of such sub-
16	section.
17	"(4) Semiconductor research.—The term
18	'semiconductor research' means any research related
19	to designing or developing a semiconductor product,
20	including qualified semiconductor manufacturing
21	property, that is at least one generation beyond the
22	taxpayer's most advanced commercially available
23	product (or the first generation if no such product
24	exists).

"(d) Coordination With Credit for Increasing 1 2 RESEARCH EXPENDITURES.— 3 "(1) IN GENERAL.—Except as provided in paragraph (2), any qualified semiconductor design ex-5 penditures for which a credit is allowed under this 6 section shall not be taken into account for purposes 7 of determining the credit allowable under section 41 8 for such taxable year. 9 "(2) Expenditures included in deter-10 MINING INCREASE TO RESEARCH ACTIVITIES.—Any 11 qualified semiconductor design expenditures for any 12 taxable year which are qualified research expenses 13 (within the meaning of section 41(b)) shall be taken 14 into account in determining the base amount or the 15 average qualified research expenses, whichever is ap-16 plicable, for purposes of applying section 41 to sub-17 sequent taxable years. Such qualified semiconductor 18 design expenditures shall not be taken into account 19 for purposes of section 41(f)(3).

20 "(e) Special Rules.—

"(1) CERTAIN PROGRESS EXPENDITURE RULES
MADE APPLICABLE.—Rules similar to the rules of
subsections (c)(4) and (d) of section 46 (as in effect
on the day before the date of the enactment of the

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- Revenue Reconciliation Act of 1990) shall apply for purposes of subsection (a).
- "(2) AGGREGATION AND ALLOCATION OF EX-PENDITURES.—Rules similar to the rules of paragraphs (1) and (2) of section 41(f) shall apply for purposes of this section.

"(f) Election for Direct Payment.—

- "(1) IN GENERAL.—In the case of any qualified property or semiconductor manufacturing property placed in service during any taxable year (with the exception of any such property to which subsection (g)(1) applied)), or in the case of any qualified semiconductor design expenditures paid or incurred during the taxable year, the amount of any credit determined under subsection (a) with respect to such property or such expenditures for such taxable year shall, at the election of the taxpayer, be treated as a payment equal to such amount which is made by the taxpayer against the tax imposed by chapter 1 for such taxable year (regardless of whether such tax would have been on such taxpayer).
- "(2) FORM AND EFFECT OF ELECTION.—An election under paragraph (1) shall be made prior to the date on which the qualified property or semiconductor manufacturing property is placed in service

1	or the last day of the taxable year in which the
2	qualified semiconductor design expenditures are paid
3	or incurred and in such manner as the Secretary
4	may prescribe. Such election, once made, shall—
5	"(A) be irrevocable with respect to the
6	qualified property, semiconductor manufac-
7	turing property, or qualified semiconductor de-
8	sign expenditures to which such election applies,
9	and
10	"(B) reduce the amount of the credit
11	which would (but for this subsection) be allow-
12	able under this section with respect to such
13	property or such expenditures for the taxable
14	year in which such property is placed in service
15	to zero.
16	"(3) Application to partnerships and s
17	CORPORATIONS.—In the case of a partnership or S
18	corporation which makes an election under para-
19	graph (1)—
20	"(A) such paragraph shall apply with re-
21	spect to such partnership or corporation with-
22	out regard to the fact that no tax is imposed
23	by chapter 1 on such partnership or corpora-
24	tion, and

"(B)(i) in the case of a partnership, each 1 2 partner's distributive share of the credit determined under subsection (a) with respect to the 3 4 qualified property, semiconductor manufac-5 turing property, or qualified semiconductor de-6 sign expenditures shall be deemed to be zero, 7 and

"(ii) in the case of a S corporation, each shareholder's pro rata share of the credit determined under subsection (a) with respect to such property shall be deemed to be zero.

"(g) Recapture.—

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- "(1) In General.—If there is a recapture event with the respect to the credits allowed under this section to any taxpayer, the tax imposed on such taxpayer by this chapter for the taxable year which includes the date of such recapture event shall be increased by the amount of such credits.
- "(2) RECAPTURE EVENT.—For purposes of this subsection, the term 'recapture event' means, with respect to the credits allowed under this section to any taxpayer, the first date on which any of the following has occurred:
- 24 "(A) Any semiconductor manufacturing fa-25 cility property with respect to which any such

1	credit was allowed is transferred to a foreign
2	entity of concern (as defined in section 9901 of
3	the William M. (Mac) Thornberry National De-
4	fense Authorization Act for Fiscal Year 2021)
5	or an entity under the influence, control, or
6	ownership of such a foreign entity of concern.
7	"(B) Foreign entities of concern (as so de-
8	fined) or entities under the influence, control,
9	or ownership of such foreign entities of concern
10	acquire a controlling interest in the taxpayer.
11	"(h) REGULATIONS AND GUIDANCE.—The Secretary
12	shall prescribe such regulations or other guidance as may
13	be necessary or appropriate to carry out the purposes of
14	this section, including regulations or other guidance with
15	respect to—
16	"(1) determining the basis of qualified property
17	and semiconductor manufacturing property,
18	"(2) any such measures as are deemed appro-
19	priate to avoid abuse or fraud with respect to the
20	credit allowed under this section,
21	"(3) ensuring that such credit is not allowed to
22	multiple taxpayers, and
23	"(4) carrying out the purposes of subsection
24	(g), including providing for the recapture of the

1	credit allowed under this section if the certification
2	described in such subsection is false.
3	"(i) Termination.—No credit shall be determined
4	under this section for any property placed in service, or
5	any qualified semiconductor design expenditures paid or
6	incurred, after December 31, 2032.".
7	(b) Conforming Amendments.—
8	(1) Section 46 of the Internal Revenue Code of
9	1986 is amended—
10	(A) by striking "and" at the end of para-
11	graph (5),
12	(B) by striking the period at the end of
13	paragraph (6) and inserting ", and", and
14	(C) by adding at the end the following new
15	paragraph:
16	"(7) the semiconductor manufacturing invest-
17	ment credit.".
18	(2) Section 49(a)(1)(C) of such Code is amend-
19	ed —
20	(A) by striking "and" at the end of clause
21	(iv),
22	(B) by striking the period at the end of
23	clause (v) and inserting a comma, and (C) by
24	adding at the end the following new clauses:

1	"(vi) the basis of any qualified prop-
2	erty (as defined in section $48D(b)(2)$)
3	which is part of a semiconductor manufac-
4	turing facility, and
5	"(vii) the basis of any semiconductor
6	manufacturing property.".
7	(3) Section 50(a)(2)(E) of such Code is amend-
8	ed by striking "or $48C(b)(2)$ " and inserting
9	" $48C(b)(2)$, or $48D(f)(1)$ ".
10	(4) Section 59A(b)(1)(B)(ii) of such Code is
11	amended—
12	(A) in subclause (I), by striking "plus",
13	(B) by redesignating subclause (II) as sub-
14	clause (III), and
15	(C) by inserting after subclause (I) the fol-
16	lowing:
17	"(II) the credit allowed under section 38
18	for the taxable year which is properly allocable
19	to the portion of the investment credit deter-
20	mined under section 46 that is properly allo-
21	cable to section 48D(a), plus".
22	(5) The table of sections for subpart E of part
23	IV of subchapter A of chapter 1 of such Code is
24	amended by inserting after the item relating to sec-
25	tion 48C the following new item:

[&]quot;Sec. 48D. Semiconductor manufacturing investment credit.".

- 1 (c) Effective Date.—The amendments made by
- 2 this section shall apply to property placed in service after
- 3 December 31, 2022, and to qualified semiconductor design
- 4 expenditures paid or incurred after December 31, 2022,
- 5 under rules similar to the rules of section 48(m) of the
- 6 Internal Revenue Code of 1986 (as in effect on the day
- 7 before the date of the enactment of the Revenue Reconcili-
- 8 ation Act of 1990).

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